

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	I_D
20V	250mΩ@4.5V	0.9A
	280mΩ@2.5V	

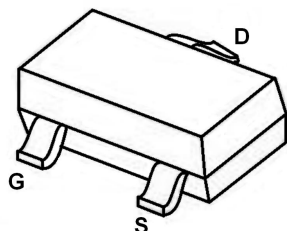
Feature

- Advanced trench technology
- Excellent $R_{DS(on)}$
- Low gate charge
- ESD Protection

Application

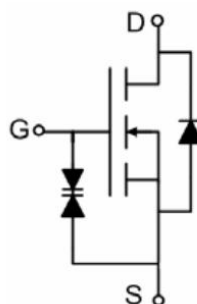
- Battery protection
- Load switch
- Uninterruptible power supply

Package

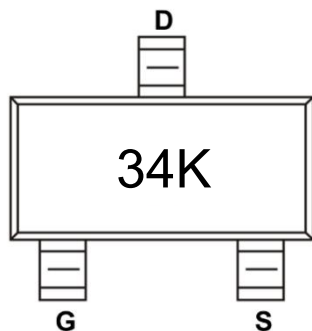


SOT-523

Circuit diagram



Marking



Absolute maximum ratings ($T_J=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	± 10	V
Continuous Drain Current ¹⁾ ($V_{GS}=10\text{V}$, $T_C=25^{\circ}\text{C}$)	I_D	0.9	A
Continuous Drain Current ¹⁾ ($V_{GS}=10\text{V}$, $T_C=100^{\circ}\text{C}$)	$I_D(100^{\circ}\text{C})$	0.6	A
Pulsed Drain Current	I_{DM}	3.6	A
Power Dissipation ²⁾ ($T_C=25^{\circ}\text{C}$)	P_D	0.23	W
Thermal Resistance Junction to Ambient ¹⁾	$R_{\theta JA}$	543	$^{\circ}\text{C/W}$
Operating Junction Temperature	T_J	$-55 \sim +150$	$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	$-55 \sim +150$	$^{\circ}\text{C}$

Electrical characteristics ($T_J=25^{\circ}\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	20			V
Zero gate voltage drain current	I_{DSS}	$V_{DS}=20V, V_{GS}=0V$			1	μA
Gate-body leakage current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 10V$			± 10	μA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.5	0.7	1.2	V
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS}=4.5V, I_D=0.5A$		135	250	m Ω
		$V_{GS}=2.5V, I_D=0.4A$		195	280	
Dynamic characteristics ³⁾						
Input Capacitance	C_{iss}	$V_{DS}=10V, V_{GS}=0V, f=1MHz$		60		pF
Output Capacitance	C_{oss}			22		
Reverse Transfer Capacitance	C_{rss}			12		
Total Gate Charge	Q_g	$V_{DS}=10V, V_{GS}=4.5V, I_D=0.9A$		1		nC
Gate Source Charge	Q_{gs}			0.28		
Gate Drain Charge	Q_{gd}			0.22		
Turn-on delay time	$t_{d(on)}$	$V_{DS}=10V, V_{GS}=4.5V, I_D=0.5A$ $R_G=10\Omega$		2		nS
Turn-on Rise Time	t_r			19		
Turn-off delay time	$t_{d(off)}$			10		
Turn-off Fall Time	t_f			23		
Source-Drain Diode characteristics						
Body-Diode Continuous Current	I_S				0.9	A
Diode Forward voltage	V_{SD}	$V_{GS}=0V, I_S=0.9A$			1.2	V

Notes:

- 1) The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2) The power dissipation is limited by 150 $^{\circ}\text{C}$ junction temperature.
- 3) Guaranteed by design, not subject to production testing.

Typical Characteristics

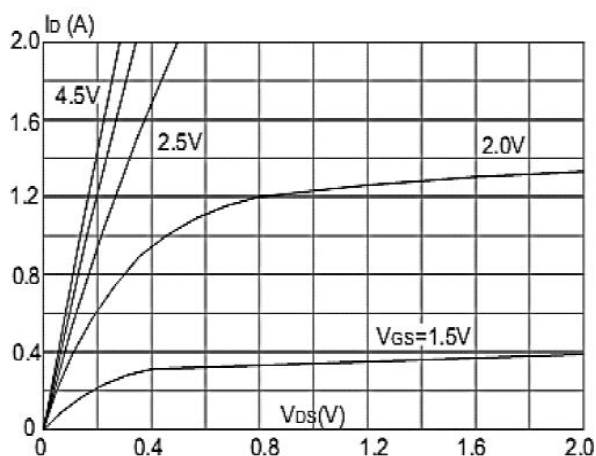


Figure1: Output Characteristics

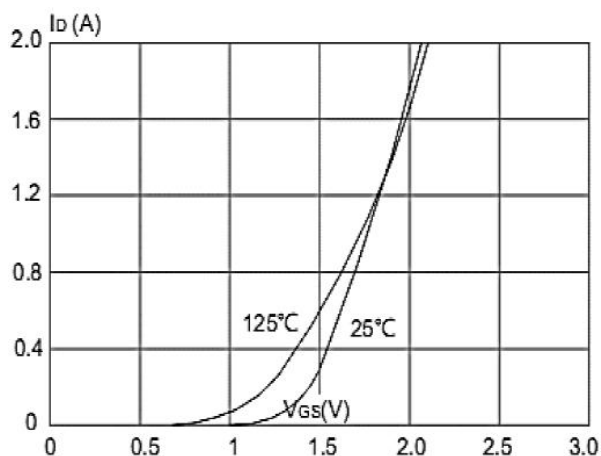


Figure 2: Typical Transfer Characteristics

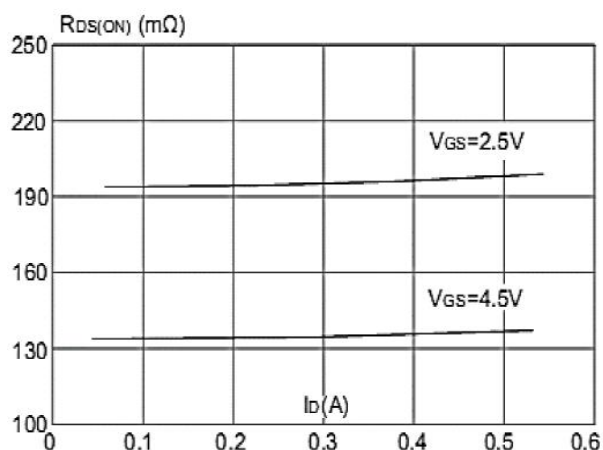


Figure 3: On-resistance vs. Drain Current

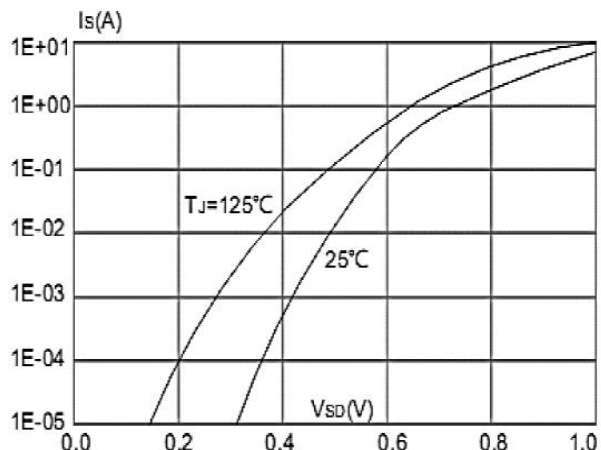


Figure 4: Body Diode Characteristics

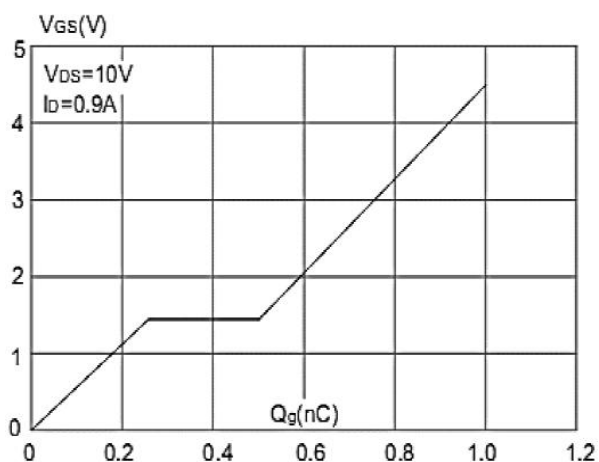


Figure 5: Gate Charge Characteristics

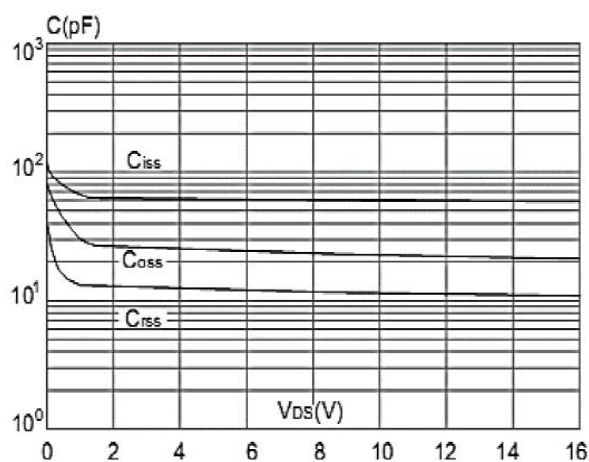


Figure 6: Capacitance Characteristics

Typical Characteristics

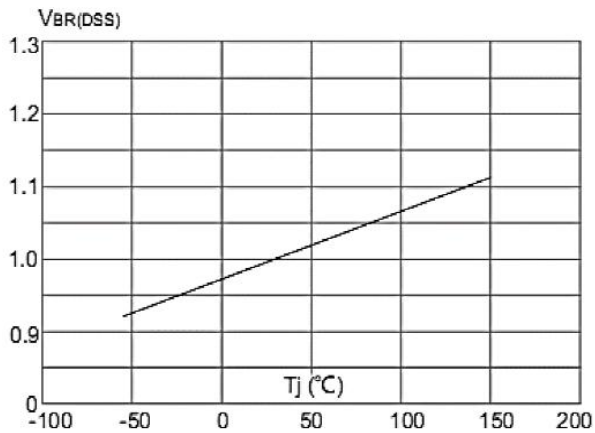


Figure 7: Normalized Breakdown Voltage vs Junction Temperature

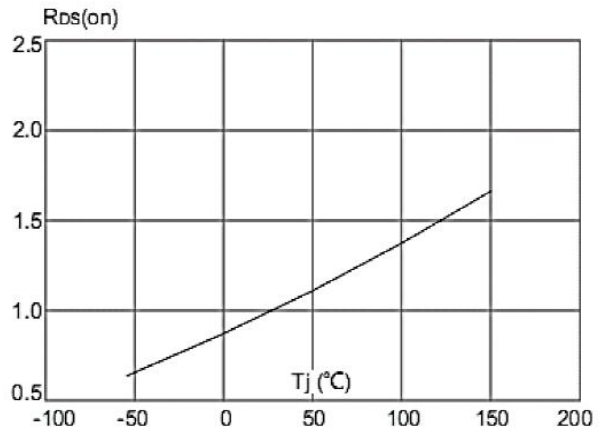


Figure 8: Normalized on Resistance vs. Junction Temperature

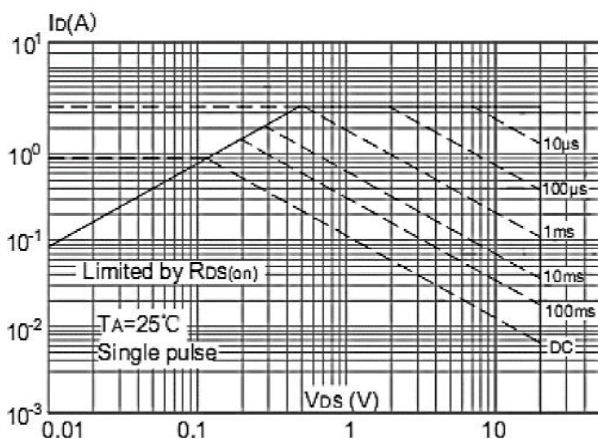


Figure 9: Maximum Safe Operating Area

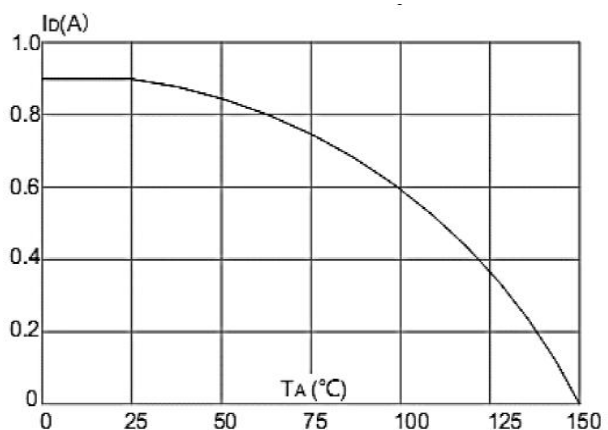


Figure 10: Maximum Continuous Drain Current vs. Ambient Temperature

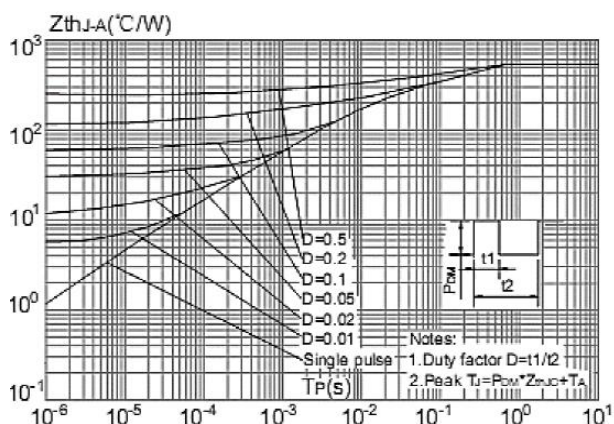
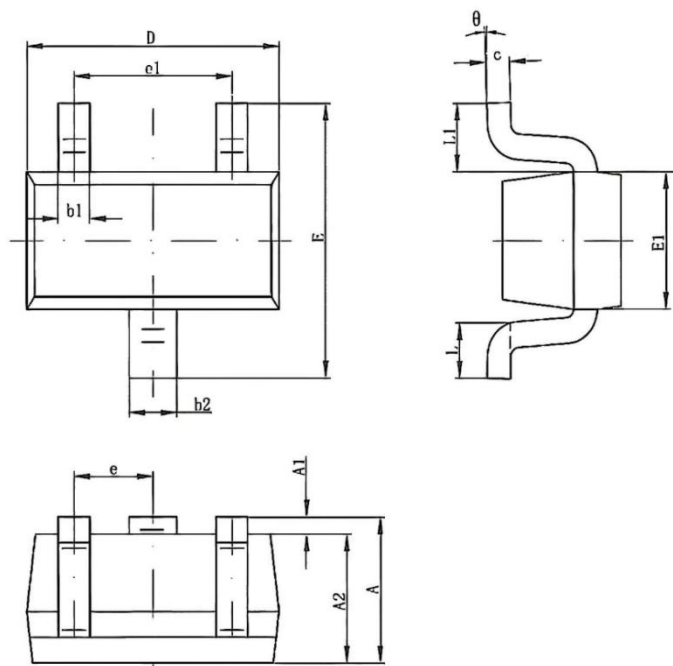


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Ambien

SOT-523 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.600	0.900	0.024	0.035
A1	0.000	0.100	0.000	0.004
A2	0.600	0.800	0.024	0.031
b1	0.150	0.350	0.006	0.014
b2	0.250	0.450	0.010	0.018
C	0.100	0.200	0.004	0.008
D	1.500	1.700	0.059	0.067
E	1.450	1.750	0.057	0.069
E1	0.700	0.900	0.028	0.035
e	0.500 TYP.		0.020 TYP.	
e1	0.900	1.100	0.035	0.043
L	0.400 REF.		0.016 REF.	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°